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Customer No. 22,852 Attorney Docket No. 07553.0009

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)
Michiaki SANO	) Group Art Unit: 1765
Serial No.: 09/671,201	) Examiner: L. Vinh
Filed: September 28, 2000	7
For: PLASMA PROCESSING METHOD	RECE FEB-5
Assistant Commissioner for Patents Washington, DC 20231	CEIVED 3-5 2003 0 MAIL ROOM
Sir:	

## <u>AMENDMENT</u>

In reply to the Office Action dated October 3, 2002, the period for reply having been extended for one month by a request for extension and fee payment filed concurrently herewith, please amend the application as follows:

## **IN THE CLAIMS:**

Please cancel claims 10-28 and 38-40 without prejudice or disclaimer, amend claim 32, and add new claims 41-62, as follows:

32. (Amended) A plasma processing method comprising:

etching a film by utilizing a resist film as a mask;

ashing the film with a first high-frequency biasing power level substantially halfway through the resist film, after etching; and

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